# A Study of the Self-Passivation of Space-Survivable POSS Kapton Polyimides



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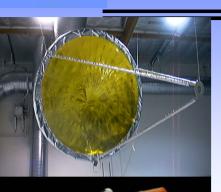
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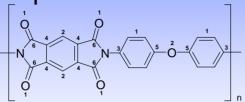


### Goal



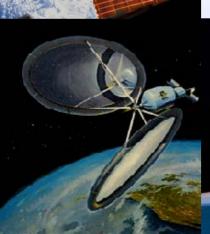






Our goal is to create an efficient drop-in replacement for Kapton that:

- Has increased space survivability due to resistance to atomic oxygen, thermal cycling, solar UV and VUV radiation, protons and electrons.
- 2. Is **Self-Passivating** based on hybrid organic/inorganic nanocomposite incorporation
- 3. Has superior optical properties, low solar absorptance, high thermal reflectance
- 4. Has excellent mechanical thermal properties.







### Atomic Oxygen in Lower Earth Orbit



### LEO Environment (Altitudes of 200 to 1500 km)

- Atomic Oxygen (AO): ~10<sup>6</sup> 10<sup>8</sup> atoms/cm<sup>3</sup>, up to 90 % of the atmosphere at 500km (typical altitude for international space station).
- Typical orbital speed of spacecraft is 7.8 km/sec
- Actual AO flux on spacecraft
   ~10<sup>12</sup> 10<sup>14</sup> atoms/cm<sup>2</sup>•s
- AO Collision energy ~ 5eV
   (C-C bond energy ~ 4 eV,
   C-N ~ 3eV, Si-O ~ 8.3eV)
- Low-energy and high energy charged particles.
- Thermal cycling -50 to 150°C
- Solar VUV and UV radiation (~ 100 - 400 nm)
- Bond scission and radical formation can lead to embrittlement.

Bond	Dissociation Energy (eV)	λ <b>(nm)</b>	Material
-C <sub>6</sub> H <sub>4</sub> -C(=O)-	3.9	320	<b>Kapton</b> ®
C-N	3.2	390	Kapton <sup>®</sup>
Si-O	8.3	150	Nanocomposite





**Scanning Electron** 

Of Kapton MLI Surface.

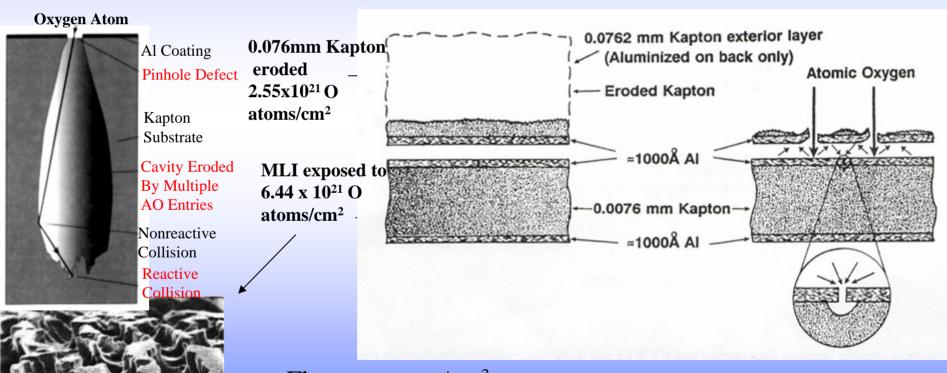
Micrograph \

#### AO Undercutting Study of Aluminized-Kapton MLI Kim K. de Groh and Bruce A. Banks Spacecraft and Rockets, Vol. 31, No. 4, (1994)



#### MLI were flown 5.8 yrs in LEO on the Long Duration Exposure Facility.

Total AO Exposure: 9 x 10<sup>21</sup> atoms/cm<sup>2</sup> 95% of Al-Kapton underwent underpinning.



Fluence atoms/cm<sup>3</sup>:

Eroded material divided by

Kapton erosion yield of 3 x 10<sup>21</sup> cm<sup>3</sup>/atom.

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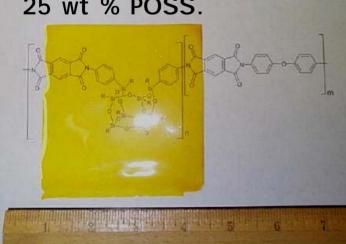
### **POSS-Kapton Polyimides**



$$H_2N$$
  $O$   $NH_2$ 

ODA

### transparent films at 25 wt % POSS.



- POSS Polyimides do not lose rigidity above the glass transition temperature.
- ➤ Tg of POSS polyimides is 5 10 % lower than polyimides (414°C).
- Room temperature modulus unaffected by POSS.
- ➤ High temperature modulus (above 430°C) is increased with POSS content.



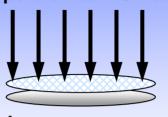
### **O-Atom Etching Experiment**

Total AO fluence of  $8.47 \times 10^{20}$  atoms cm<sup>-2</sup> (100,000 pulses)





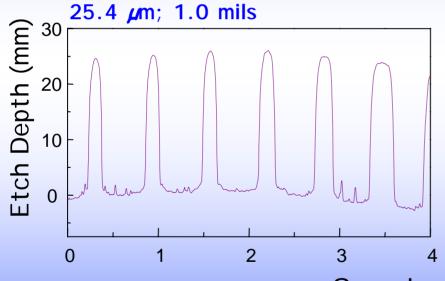
Hyperthermal AO Beam  $(CO_2 laser, 0 = 4.93-8.42 eV)$ 



Screen Sample

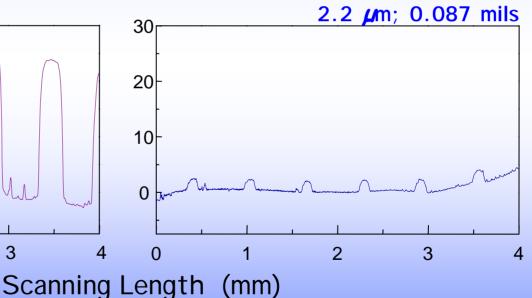
#### Kapton H Standard

Average etch depth:



Kapton 10 wt% (2 mole %) POSS

Average etch depth:



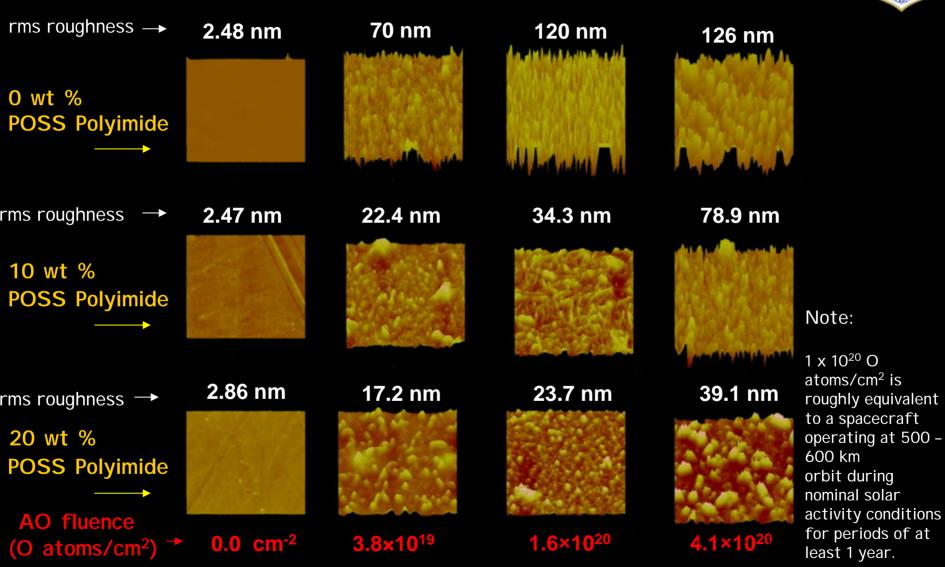
Significantly improved oxidation resistance due to a rapidly formed ceramic-like, passivating silica layer preventing further degradation of underlying virgin polymer.



### AFM Images of POSS Polyimides With increasing AO Flux.

 $(10 \times 10 \mu m; z scale = 500 nm)$ 







# Surface Atomic Concentrations (%) determined from XPS (X-ray Photoelectron Spectroscopy) Survey Scans before and after exposure to Atomic Oxygen.

 Sample	Exposure (beam pulses)	Kapton-equivalent atomic oxygen fluence (10 <sup>20</sup> O atoms cm <sup>-2</sup> )	С	0	Si	N	
0 wt% POSS polyimide	0 6 100 250	0 ~0.1 1.63 4.10	72 69 69 55	19.5 20 24 36	1 2 1 0	7 9 6 9	
10 wt% POSS polyimide	0 6 100 250	0 ~0.1 1.63 4.10	77 73 48 <b>20</b>	16 18.5 30 <b>56</b>	2 5 19 <b>23.5</b>	5 3.5 3 0.5	
20 wt% POSS polyimide	0 6 100 250	0 ~0.1 1.63 4.10	70 66 20 <b>12</b>	20 24 <b>54</b> <b>60</b>	6 7 <b>25</b> <b>26</b>	4 3 0 1	

Calculated at%: 0 wt% POSS PI: C = 75.9, O = 17.2, Si = 0, N = 6.9 10 wt% POSS PI: C = 75, O = 17.2, Si = 1, N = 6.4. 20 wt% POSS PI: C = 75, O = 17.2, Si = 1.8, N = 6.0



## Erosion of POSS Polyimides by a Beam of Hyperthermal (5eV) O Atoms

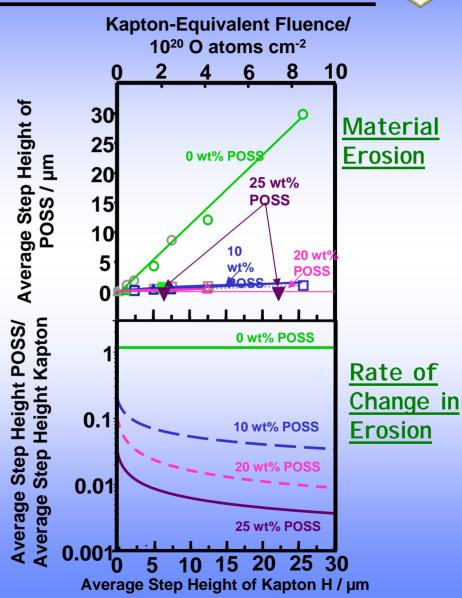


1st AO Erosion experiment: The erosion rate of the 10 and 20 wt % POSS Polyimide samples were 3.7 and 0.98 percent, respectively, of the erosion rate for Kapton H at the highest fluence used in this experiment (8.5x10<sup>20</sup> atoms cm<sup>-2</sup>).

2<sup>nd</sup> AO Erosion Experiment:

The new 25 wt% POSS polyimide samples had an erosion rate that was 0.3 percent of the erosion rate for Kapton H at a fluence of 8.5×10<sup>20</sup> atoms cm<sup>-2</sup>.

This erosion rate is one third that of the previously synthesized 20 wt% POSS polyimide.





# Self-passivation of POSS Polyimide Upon Exposure to 2.3x10<sup>20</sup> O atoms cm<sup>-2</sup>.

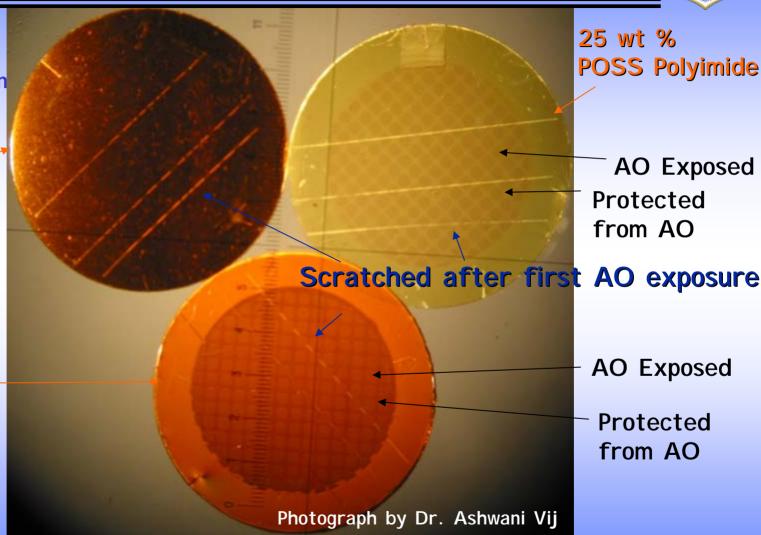


Dr. Timothy Minton Amy Brunsvold

SiO<sub>2</sub> (130 nm) / Kapton (2 mil) / Al (100nm)

Commercial Kapton H

Sample diameter = ½ inch.



Screen-protected samples were exposed to  $2.3x10^{20}$  O atoms cm<sup>-2</sup>, unprotected, scratched with a diamond scribe 1  $\mu$ m deep, screen-protected, and re-exposed to  $2.3x10^{20}$  O atoms cm<sup>-2</sup>.



### **Summary of Self-Passivation Study**



480					
		SiO <sub>2</sub> coated		25 w	

SiO <sub>2</sub> coated	
Kapton HN	
with Al	
under-coating	

Kapton H

5 µm

25 wt % POSS polyimide

0.200 µm

Erosion depth after 1st exposure to 2.3x10<sup>20</sup> O atoms cm<sup>-2</sup>.

~ 0 **µ**m

All samples were scratched 1 µm deep.

Erosion depth outside
of the scratch after
2<sup>nd</sup> exposure to
2.3x10<sup>20</sup> O atoms cm<sup>-2</sup>.



5 µm

~ 0 µm

Erosion depth inside of the scratch after 2<sup>nd</sup> exposure to

2.3x10<sup>20</sup> O atoms cm<sup>-2</sup>

7 **µ**m

5 μm

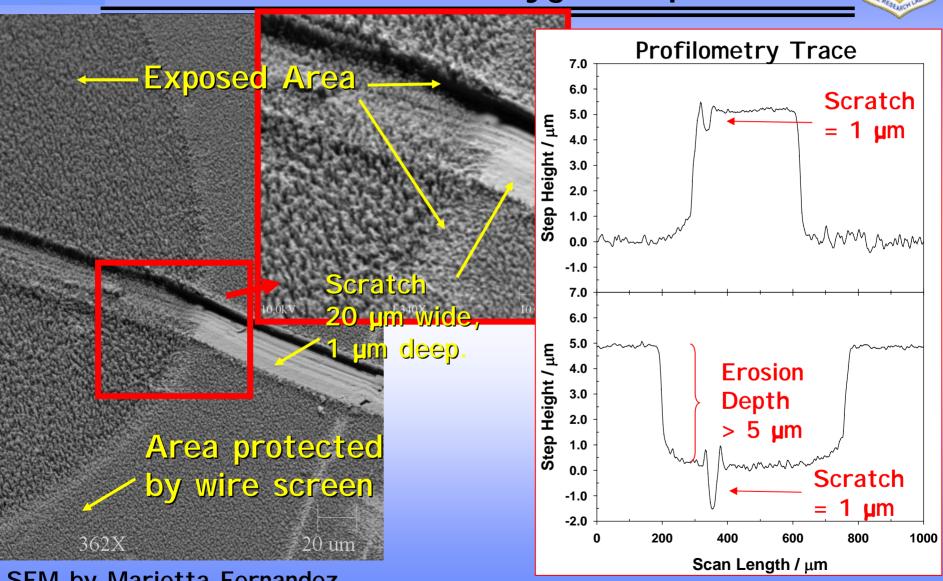
O.200 μm

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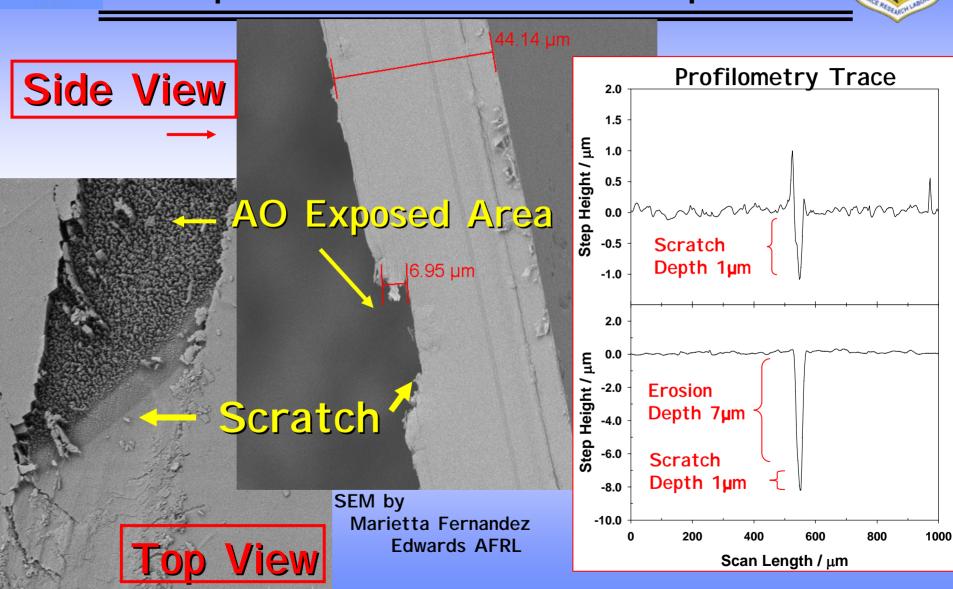
# SEM of Kapton H surface after the Second Atomic Oxygen Exposure







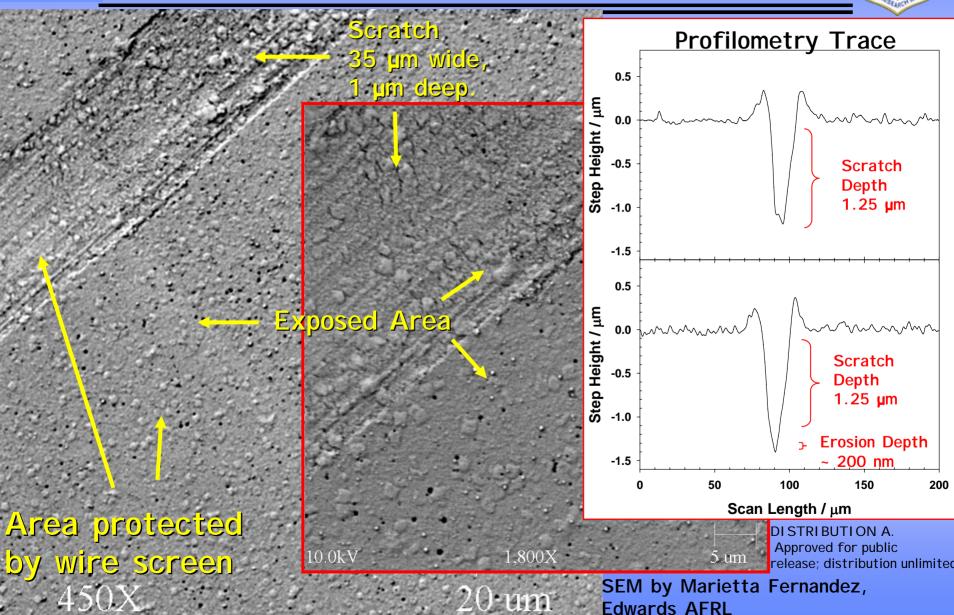
# SEM Images of Scratch on SiOx Coated Kapton After Second AO Exposure





## SEM of 25 wt % POSS Polyimide Surface After the Second Atomic Oxygen Exposure







### New POSS Monomer





➤ China Lake Naval Air Warfare Center, Weapons Division collaborators:
Dr. Michael Wright, Dr. Brian Petteys, Dr. Andy Guenthner, Dr. Gregory Yandek.

#### Recently synthesized:

Side-chain POSS diamine monomer which is relatively inexpensive and of facile synthesis.

Resultant POSS Polyimdes are transparent flexible films.

Sample	Kapton-Equivalent Fluence/10 <sup>20</sup> O atoms cm <sup>-2</sup> .	Erosion Yield
Kapton H	4.10	12.3
20 wt % main-chain POSS polyimide	4.10	0.47 Is 3.8 % of that of Kapton H.
Kapton H	3.53	10.6
7 Si8O12 wt % side-chain POSS polyimide.*	3.53	0.35 Is 3.3 % of that of Kapton H.

AO resistance is similar between main-chain and side-chain POSS polyimides.

\* equivalent SiO content to 20 wt % main-chain POSS PI

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### **Acknowledgments**



<u>Polymer Working Group</u>: Dr. Rusty Blanski, Mr. Pat Ruth, Mrs. Sherly Largo, Ms. Sarah Mazzella, 2Lt. Amy Palecek, 2Lt. Laura Moody.

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